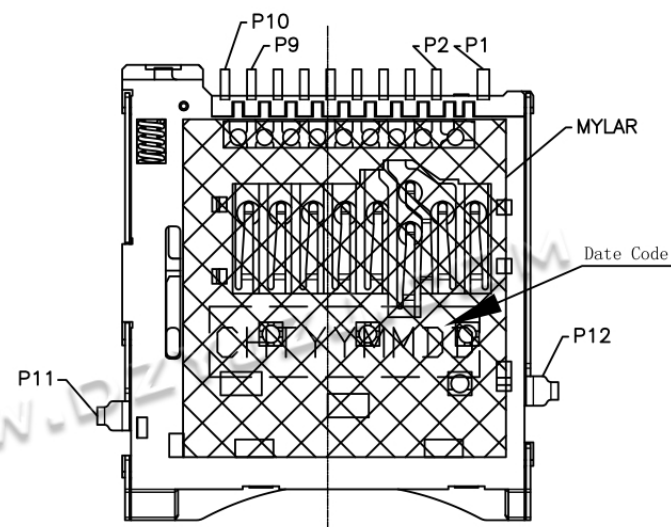
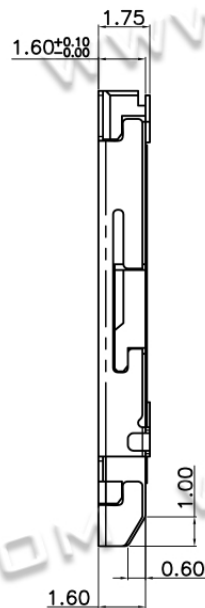
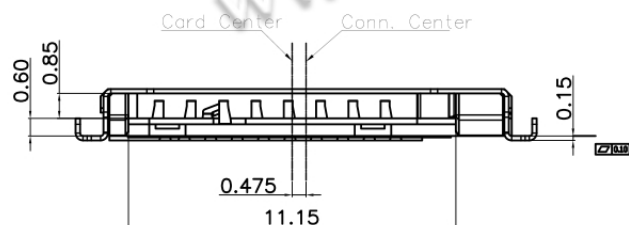
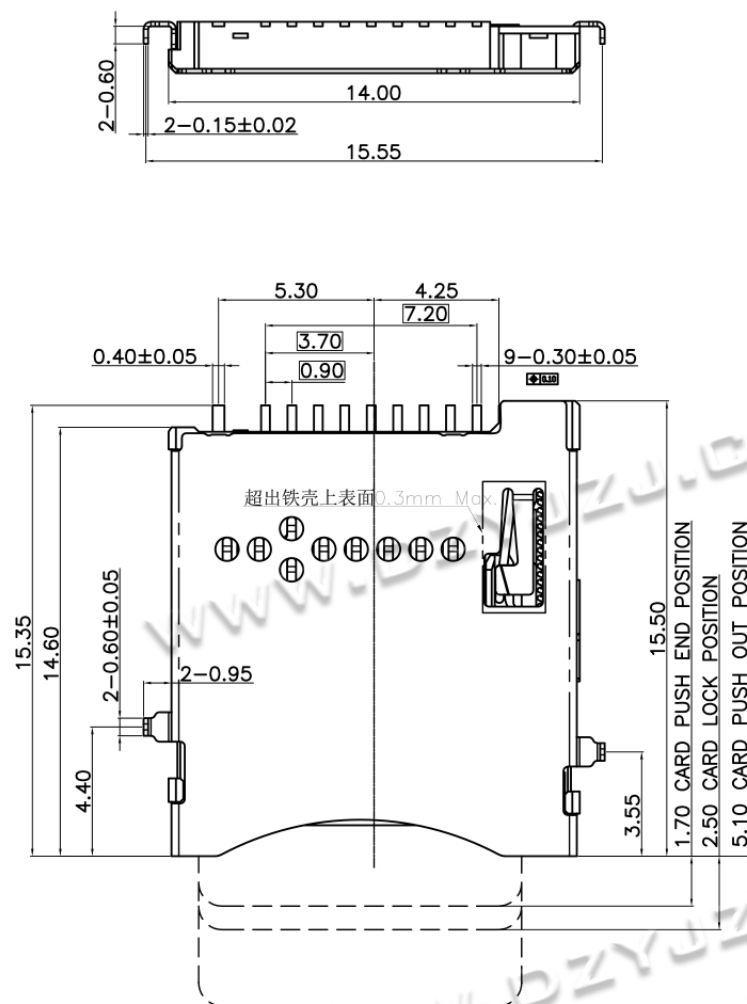
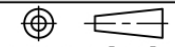
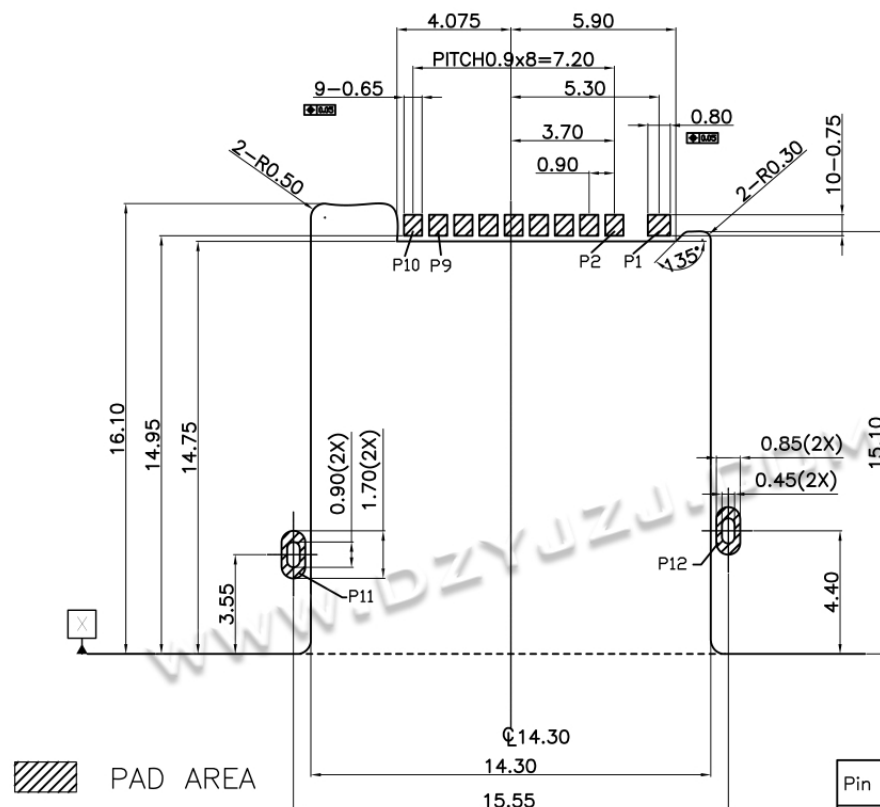




 深圳市华宇创精密电子有限公司			
TOLERANCE: X.X ±0.30 X.XX ±0.25 X.XXX ±0.15 X' ±2" X.X' ±0.5"	DRAWN BY : 陈一鸣	DATE : 2014-02-23	PART NAME: TF PUSH 沉板 1.6H
	CHECKED BY: 马跃	DATE : 2014-02-23	PART NO. HYC142-TF10-160
 UNIT: mm [inch] SCALE:1:1 SIZE: A4	APPROVED BY: 邱敏	DATE : 2014-02-23	MOLD NO.
			DRAW NO: HYC-2206011511
			SHEET NO. 1 OF 1

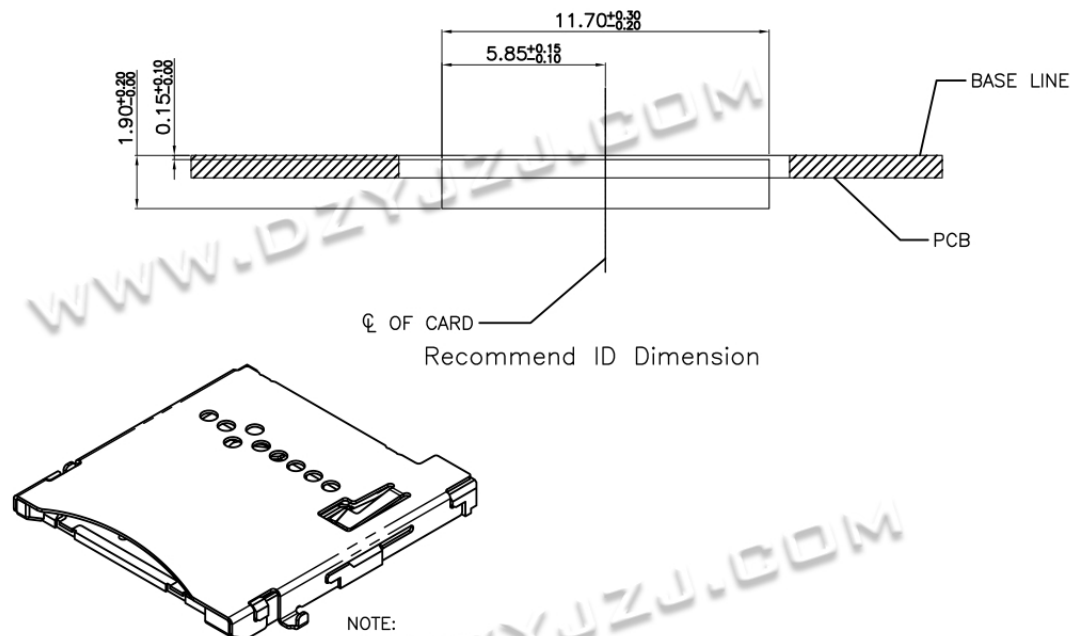


Recommended P.C.B LAYOUT
BOTTOM VIEW(CONNECTOR) (TOLERANCE+/-0.05)
TOP VIEW(SYSTEM)

Opening/Close of Switch

Card Detect Switch	
Card Uninsertion	Open
Card Half Insertion	Open
Card Insertion	Close
N/O	Open Close

Pin No.	Pin Assignment
P1	MICRO SD CD
P2	MICRO SD DAT1
P3	MICRO SD DAT0
P4	MICRO SD VSS
P5	MICRO SD CLK
P6	MICRO SD VDD
P7	MICRO SD CMD
P8	MICRO SD CD/DAT3
P9	MICRO SD DAT2
P10	MICRO SD GND
P11	MICRO SD GND
P12	MICRO SD GND



NOTE:

- 1.MATERIAL:
1-1 PLASTICS: HEAT RESISTANCE POLYMER, UL94V-0,COLOR:BLACK
1-2 CONTACT: COPPER ALLOY
1-3 SHELL; STAINLESS STEEL
- 2.PLATING:
2-1 CONTACT:
2-1-1: CONTACT AREA: PLATING Au 1u" MIN.
2-1-2: SOLDERTAIL AREA: MATTE TIN 80u" MIN. PLATING OVER Ni 30u" MIN
2-2 SHELL: SOLDERABILITY Ni 30u" MIN PLATING OVER ALL
- 3.TAIL COPLANARIT TO BE 0.10mm MAX.
- 4.PART MUST COMPLY TAI SOL HF WD-3-1-09I SOPECIFICATION
- 5.RECOMMENDING A METAL MORE THAN 0.15 THICK.
PLEASE CONFIRM SOLDILITY, IF USE A METAL MASK LESS THAN 0.15mm THICK.
- 6.PRODUCT PACKING: PLEASE REFER TO THE PACKING REGULATION



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UNIT: mm [inch] SCALE:1:1 SIZE: A4	APPROVED BY: 邱敏	DATE : 2014-02-23	DRAW NO: HYC-2206011511	SHEET NO. 1 OF 1